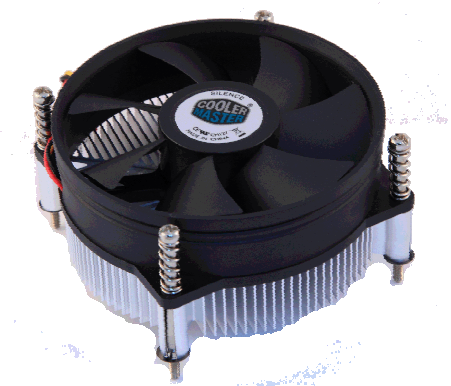




DP6-00003-N1-GP



Application

LGA 1155/1156 (Socket H2H)

Test result :

Item	Sample 1
Tc (°C)	55
Ta (°C)	25
P(W)	94.635
Rca (°C/W)	0.317

Thermal and Mechanical Spec

Thermal performance for 95W CPU

HSK Assembly Weight: 278g

CPU Loading: 40 lbf

Safety



Component Specifications

Application System 1.5U Form Factor Active Solution

Material Aluminum Extrusion

Dimension $\varnothing 93 \times 47\text{mm}$

Thermal interface
Material ShinEtsu 7762 ($\varnothing 26.5\text{mm}$)

Fan Dimension $\varnothing 92 \times 25.4\text{ mm}$

Fan Bearing Type Rifle

Fan Control PWM

Rate Voltage 12V

Life Time 40,000 hrs

Speed $2600 \pm 10\% \text{ rpm}$

Airflow 39.62 CFM (max)

Noise 28.75 dB(A) (max)

Connector Lead Wire: UL1061 AWG#26

Pin 1: black wire -----(-)

Pin 2: red wire -----(+)

Pin 3: yellow wire -----(F00)

Pin 4: blue wire -----(PWM)

Housing Wieson G2510C888-001 or Equivalent

Terminal Wieson G2511-T1 or Equivalent

*All readings are typical values at rated voltage.

*Specifications are subjected to change without notice.